

#### **Description**

The NTMFS4821N uses advanced trench technology to provide excellent R<sub>DS(ON)</sub>, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a

# Battery protection or in other Switching application. DFN5X6-8L

 $V_{DS} = 30V I_{D} = 70A$ 

**General Features** 

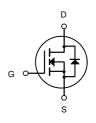
 $R_{DS(ON)} < 7 \text{ m}\Omega \text{ V}_{GS}=10\text{V}$ 

**Application** 

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

#### **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
NTMFS4821N	DFN5X6-8L	HXY MOSFET	5000

#### Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

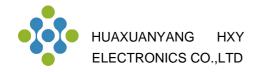
Symbol	Parameter	Rating	Units	
VDS	Drain-Source Voltage	30	V	
Vgs	Gate-Source Voltage	V		
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	А		
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	40	А	
Ірм	Pulsed Drain Current <sup>2</sup> 140		А	
EAS	Single Pulse Avalanche Energy <sup>3</sup>	Single Pulse Avalanche Energy <sup>3</sup> 115.2		
las	Avalanche Current	Avalanche Current 48		
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	Total Power Dissipation <sup>4</sup> 59		
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>4</sup>	2	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	T <sub>J</sub> Operating Junction Temperature Range -55 to 150		°C	
Reja	Thermal Resistance Junction-Ambient <sup>1</sup>	Thermal Resistance Junction-Ambient <sup>1</sup> 62		
Rыс	Thermal Resistance Junction-Case <sup>1</sup>	2.1	°C/W	



#### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
△BVDSS/△TJ	BVDSS Temperature Coefficient	ent Reference to 25°C , I <sub>D</sub> =1mA		0.028		V/°C
	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =30A		5.7	7	
RDS(ON)		V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		11	13	$\mathbf{m}\Omega$
V <sub>GS</sub> (th)	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.2		2.5	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS-VDS , ID -250UA		-6.16		mV/°C
loss	Drain-Source Leakage Current	$V_{DS}$ =24V , $V_{GS}$ =0V , $T_{J}$ =25 $^{\circ}$ C			1	
1500	_	$V_{DS}$ =24V , $V_{GS}$ =0V , $T_{J}$ =55 $^{\circ}$ C			5	uA
Igss	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20V$ , $V_{DS}$ = $0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =30A		43		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7		Ω
Qg	Total Gate Charge (4.5V)			20		
Qgs	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		7.6		nC
Q <sub>gd</sub>	Gate-Drain Charge			7.2		
Td(on)	Turn-On Delay Time			7.8		
Tr	Rise Time	V <sub>DD</sub> =15V , V <sub>GS</sub> =10V ,		15		ns
Td(off)	Turn-Off Delay Time	R <sub>G</sub> =3.3		37.3		
Tf	Fall Time	I <sub>D</sub> =15A		10.6		
Ciss	Input Capacitance			2295		
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		267		pF
Crss	Reverse Transfer Capacitance			210		
ls	Continuous Source Current <sup>1,5</sup>				81	Α
lsм	Pulsed Source Current <sup>2,5</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			160	Α
VsD	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1	V
t <sub>rr</sub>	Reverse Recovery Time			14		nS
Qrr	Reverse Recovery Charge			5		nC

- 1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3.The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V, $V_{GS}$ =10V,L=0.1mH, $I_{AS}$ =48A 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



### **Typical Characteristics**

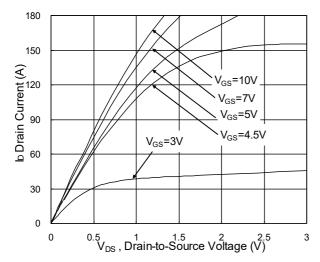


Fig.1 Typical Output Characteristics

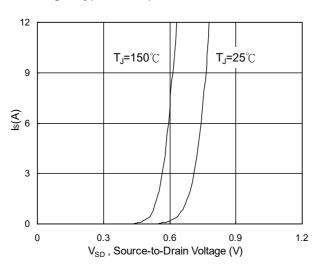


Fig.3 Forward Characteristics of Reverse

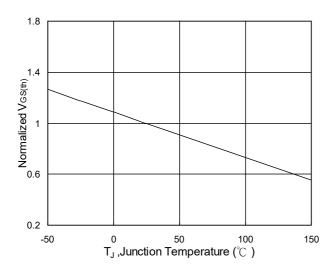


Fig.5 Normalized  $V_{\text{GS(th)}}$  vs.  $T_{\text{J}}$ 

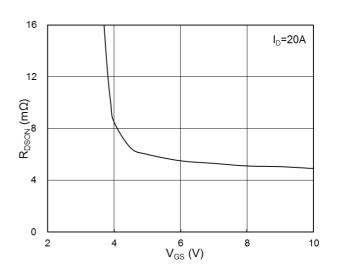


Fig.2 On-Resistance vs. G-S Voltage

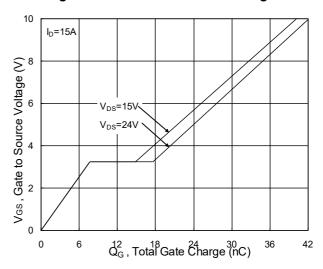


Fig.4 Gate-Charge Characteristics

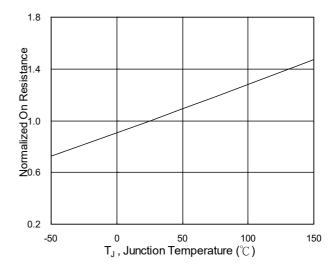
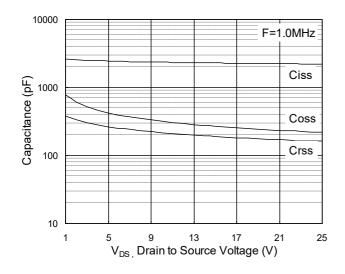


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>



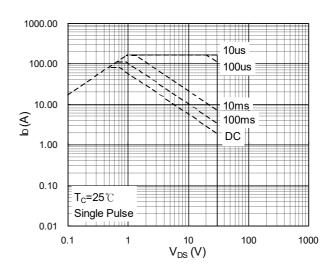


Fig.7 Capacitance

Fig.8 Safe Operating Area

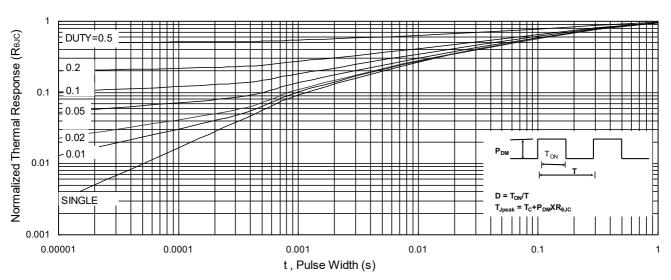


Fig.9 Normalized Maximum Transient Thermal Impedance

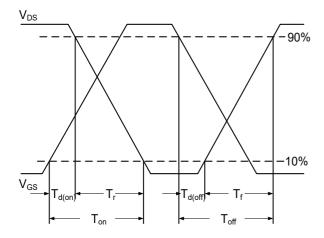


Fig.10 Switching Time Waveform

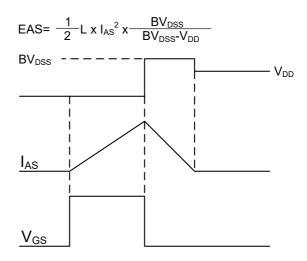
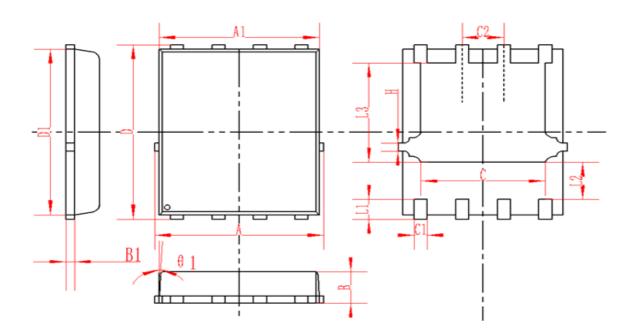


Fig.11 Unclamped Inductive Switching Waveform



## **DFN5X6-8L Package Information**



SYMBOL		MM		INCH		
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX
Α	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1		0.254REF			0.010REF	
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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